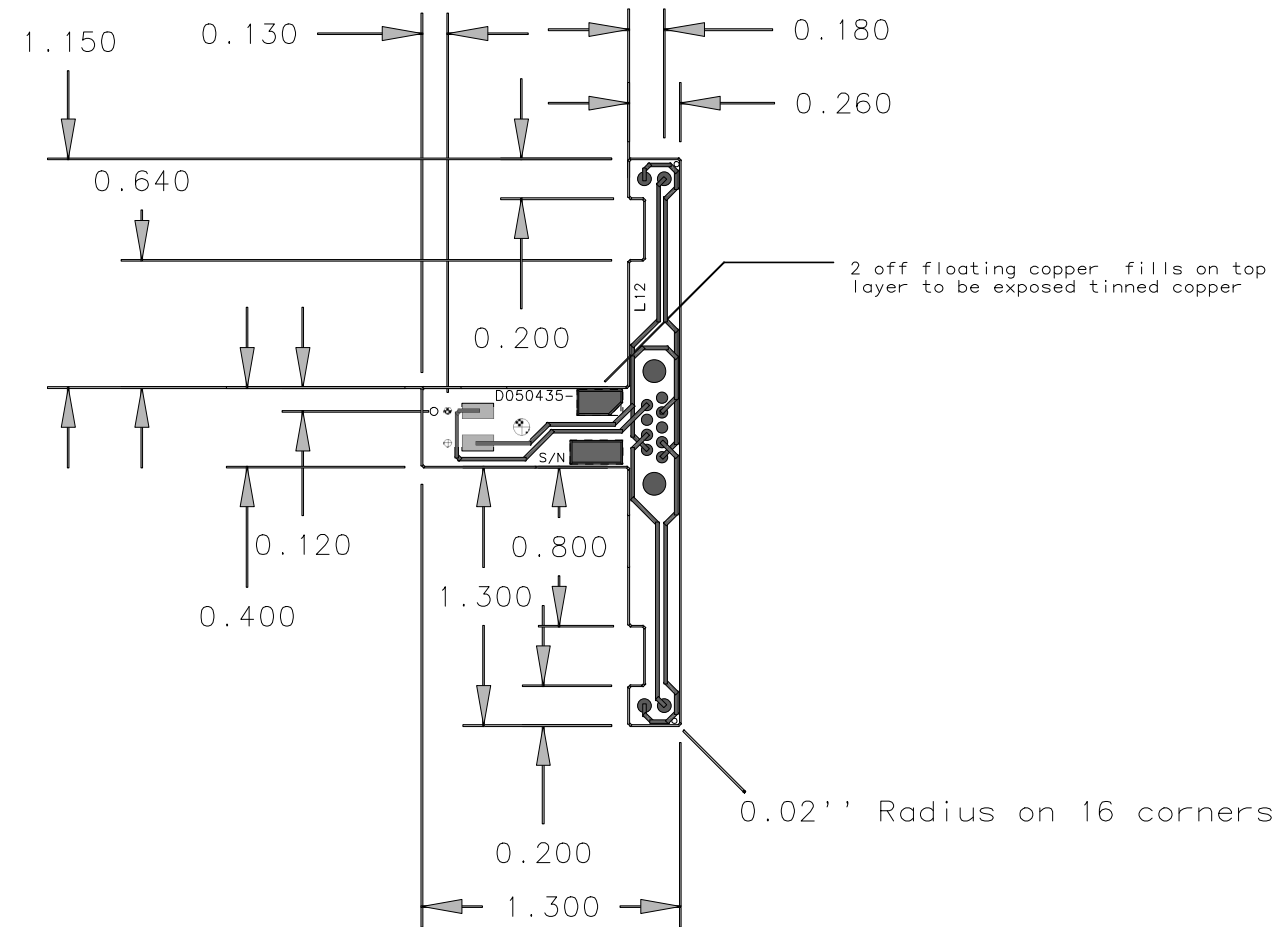


DO NOT SCALE

Rev. C 10 APR 2008 DCN # E060262 Drawing Tree # E060243
 This Drawing has been registered under the following:-

D050435-C-K

J.Bryant 10-04-08, Advanced LIGO SUS BOSEM Flexi Circuit



PCB FABRICATION DETAILS:-

- 1) Material: Kapton
- 3) Thickness: 0.008''
- 4) Copper: 1oz on all layers
- 5) Layer Details:-
 - Layer_1 0.008''
 - Layer_2
- 6) There shall be no silk screen printing on this pcb
- 7) Resist layers to be generated from copper data

Associated PCB Data Files:-

- Layer_1 Top Layer
- Layer_2
- Layer_3 Fabrication Drawing
- Drill_plt_unplt
- Drill_table_report
- Neutral_file

8	Title changed to BOSEM	J.Bryant	10-04-08
7	No Change, Rev C	J.Bryant	20-12-07
6	Increase SN area, Rev B	J.Bryant	18-04-07
5	Text changed to rev A	J.Bryant	7-11-06
4	Removed Resistors	J.Bryant	11/09-06
3	Removed vias	S.Aston	10/5/6
2	Update for Noise Prototype	S.Aston	9/12/5
1	Initial Release	S.Aston	17/11/04
ISSUE:	NCR REFERENCE	APP'D BY	DATE

PROJECT: Advanced LIGO	
SUBSYSTEM: SUS	UNIT:OSEM Flexi Circuit
FILE LOC'N: /ADV/LIGO/elec/0SEM/AL0001	
CAD SYSTEM: MENTOR(C4)	SHEET SIZE: A3
DRAWN BY: D.Hoyland	DATE: 16/11/04
APP'D BY: S.Aston	DATE: 17/11/04

ALL DIMENSIONS IN INCHES UNLESS OTHERWISE STATED
 SEE UOB SPECIFICATION GEN/UB/SPEC/001 FOR
 DIMENSIONAL TOLERANCES
 SCALE 1:1

THE UNIVERSITY OF BIRMINGHAM
 DEPT OF ASTROPHYSICS AND SPACE RESEARCH